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Demonstration of Low Voltage and Functionally Complete Logic Operations Using Body-Biased Complementary and Ultra-Thin ALN Piezoelectric Mechanical Switches

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Abstract

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DEMONSTRATION OF LOW VOLTAGE AND FUNCTIONALLY COMPLETE LOGIC OPERATIONS USING BODY-BIASED COMPLEMENTARY AND ULTRA-THIN ALN PIEZOELECTRIC MECHANICAL SWITCHES

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ABSTRACT

This paper reports, for the first time, on the demonstration of low voltage and functionally complete logic elements (NAND and NOR) implemented by using body-biased complementary and ultra-thin (250 nm thick) Aluminum Nitride (AlN) based piezoelectric mechanical switches. This work presents, firstly, the importance of scaling AlN films for the demonstration of ultra-thin AlN switches and, secondly, the implementation of a new actuation scheme based on body biasing to lower the switch threshold voltage. Four of these ultra-thin switches were connected together to synthesize functionally complete MEMS logic gates (NAND and NOR) with a $\pm 2V$ swing and a body-bias voltage $< 8 V$.

INTRODUCTION

The CMOS industry has thrived thanks to the scaling of the transistor over the past few decades and has been able to implement smaller, faster and more energy efficient devices. Nonetheless, with the continuous scaling of the planar bulk metal-oxide semiconductor field effect transistors (MOSFETs) to the nano-dimensions the International Technology Roadmap for Semiconductors (ITRS) [1] has recognized the emergence of some key issues in these extremely small devices, such as the variability and magnitude of the threshold voltages, the source-to-drain leakage in the standby state and the increased effect of parasitics like source/drain resistance due to the ultra-thin body of the device. For these reasons, the ITRS is also emphasizing the need to investigate alternate devices and technologies like NEMS switches that will lower transistor switching voltages and consume less power. These devices have the potential to replace the CMOS transistors in applications where low power consumption is of paramount importance.

Regular CMOS MOSFETs exhibit passive power dissipation due to the presence of a physical semiconductor channel between the source and the drain. The presence of this channel causes sub-threshold conduction and leads to standby power consumption.

The replacement of this channel with an air-gap would drastically reduce the leakage power consumption and lower the subthreshold slope well below the 60 mV/dec level of CMOS. Therefore, the presence of an air-gap simultaneously enables the reduction in leakage current and the implementation of a device with a threshold voltage of just few mVs. This new class of switches, based on an air-gap, can be considered *mechanical transistors*. MEMS switches [2] are readily available prototypes for verifying the characteristics of the mechanical transistor before scaling it into the NEMS regime. For this purpose, we have built an AlN piezoelectric MEMS switch [3]-[4]. Differently from all other actuation mechanisms like electrostatic [5]-[6], electromagnetic [7] and thermal [8], piezoelectric actuation gives us the advantage of being extremely linear in nature and requiring low power for actuation. Lead Zirconate Titanate (PZT) [9]-[10] and AlN [3]-[4] are the two most commonly used piezoelectric materials for realizing MEMS switches. Over PZT, AlN has the advantage of being CMOS compatible, exhibiting lower leakage current for comparable film thicknesses and having shown preservation of piezoelectric coefficients when scaled from bulk to ultra-thin films [11]. The scalability of AlN films makes it more amenable for NEMS switch development. In order to scale NEMS actuator, the two most important characteristics that need to be considered are deflections (δ) and resonance frequency (f_n). Displacement, in fact, puts a constraint on the required switching voltage, achievable switching forces and manufacturability of the airgap. The frequency dictates the speed of operation of the transistor, which should be desirably scaled to a few nanoseconds. The relationship of deflection and resonance frequency to the various design parameters such as length (L) and thickness (t) are shown in equation (1).

$$\delta \propto \left(\frac{L}{t}\right)^2 \quad \text{and} \quad f_n \propto \frac{t}{L^2} \quad (1)$$

The product of these two parameters shows that the key parameter that needs to be scaled in order to obtain high deflection and high resonance frequency is the film thickness, as shown in equation (2).

$$f_n \delta \propto \frac{1}{t} \quad (2)$$

With the intent of moving towards nanoscaled devices, this work shows the first AlN piezoelectric switches developed by using 250 nm thick films. These films have shown a marked reduction in the actuation voltages of the switches and simultaneously permitted the demonstration, for the very first time, of low voltage ($\pm 2V$) functionally complete (NAND and NOR) MEMS logic gates.

PRINCIPLE OF OPERATION

For demonstration of complementary logic using AlN MEMS switches a novel actuation methodology was used. In analogy to 4-terminal CMOS devices, the actuation scheme is called the body-biased actuation.

Piezoelectric actuation necessitates the presence of two actuation electrodes that sandwich the piezoelectric material and create an electric field across it, which generates the strain that leads to actuation. A body bias stands for a constant and floating voltage applied to one of the actuation electrodes. Conventionally, to turn the switch-on, one actuation electrode is shorted to ground and the other electrode has a potential greater than the threshold voltage. This mode of actuation can be referred to as the ‘grounded actuation’ mode. In the ‘body-biased’ mode of actuation the previously grounded actuation electrode is biased to a constant voltage (body-bias) very close in magnitude (but opposite in polarity) to the threshold voltage. In this scenario, actuation (closing and opening of the switch) can be achieved by applying a very small voltage on the other actuation electrode. Figure 1 schematically shows and compares the two actuation modes.

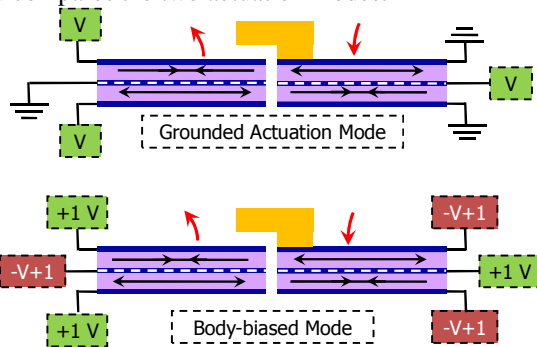


Fig. 1: Schematic representation of the principle of operation of an AlN switch in grounded and body-biased mode of operation. By applying a bias to one of the metal layers ($-V + 1V$), the same effective electric field required to open and close the switch is applied across the AlN layer with just 1 V. The gate voltage can be lowered to $< 1V$ (1 V is used in the figure).

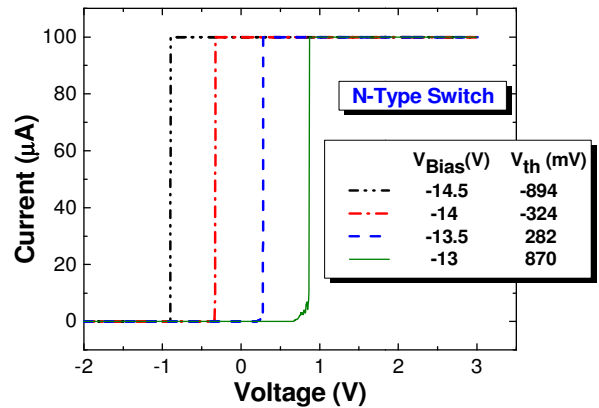


Fig. 2: Experimental data verifying that the switch threshold voltage (V_{th}) can be tuned by varying the value of the body bias. This data shows that the body-bias technique enables the implementation of variable threshold voltages on the same die and in the same process. The current measurement was limited to a maximum value of $100 \mu A$.

Previously, threshold voltage manipulation [12] had been demonstrated in electrostatic switches by introducing a pre-charged electrode. In that case the pre-charging voltages were very high and there was a significant variation in threshold (pull-in) voltage with respect to time. Instead by using the body-biased threshold voltage control method, the threshold voltage of a piezoelectric switch can be linearly tailored to be any value, negative or positive, as shown in Figure 2.

The body-biasing technique also allows us to synthesize n or p-type switches out of the same identical device without any changes in the design or fabrication. As expected, the devices also exhibit a very low subthreshold slope, measured to be $< 1mV/dec$.

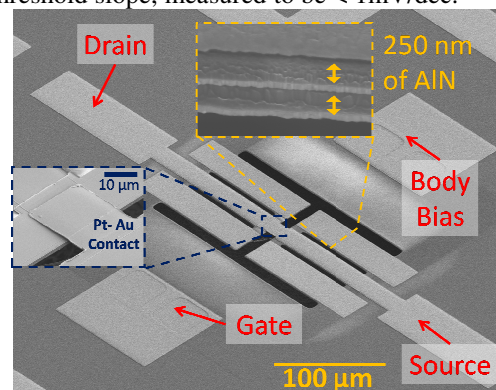


Fig. 3: SEM of an ultra-thin film dual-beam AlN switch illustrating the source, drain, gate and body bias terminals. One inset (top) shows the cross-sectional view of the actuator and the stacked AlN nano-films. The second inset (left) shows the flat tip and the nanogap in the switch.

The major impact of the body-biasing technique is the ability to reduce the threshold voltage, which has been experimentally pushed to values as low as 10-30 mV [13]. The scaling of the AlN films to 250 nm was introduced in order to reduce the required body-bias voltages and pave the way to ultimately scale the actuator dimensions to achieve fast switching at high forces. A reduction in the body bias, in fact, gives us more control over the desired threshold voltage. Figure 3 shows an SEM of an AlN MEMS switch with an inset showing the cross-section of the ultra-thin films that were used to make it. By leveraging on the scaling of the AlN films both the NAND and NOR gates were synthesized at low switching voltages ($\pm 2V$) and with a body bias $< 8 V$.

Despite the higher piezoelectric coefficient of PZT, previously shown PZT based NAND gates [14] required elevated voltages (20 V). Therefore, this thin-film AlN demonstration constitutes a significant step forward in the realization of low-voltage logic elements.

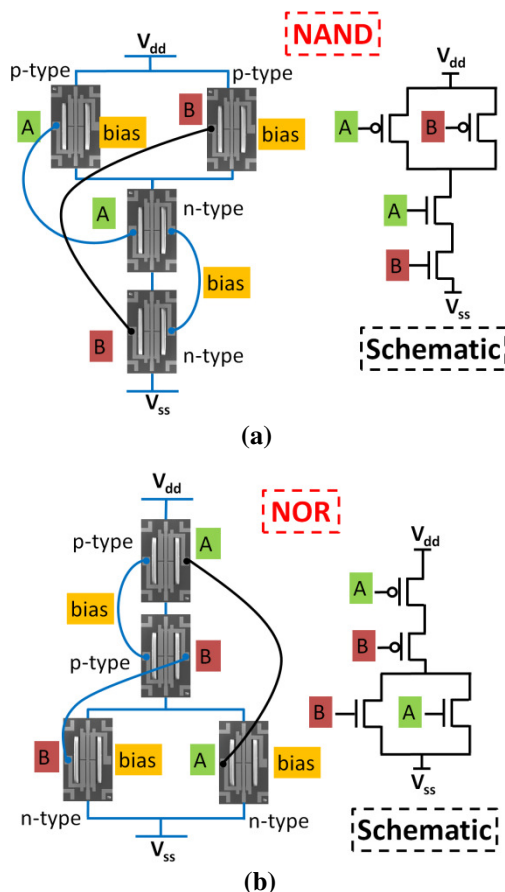


Fig 4: Layout showing the wiring of (a) the NAND and (b) the NOR for the testing of complementary logic and the electronic schematic of a conventional NAND and NOR, respectively.

RESULTS

Both the NAND and NOR structures were formed by wire-bonding four separate ultra-thin AlN switches in the desired configuration. Wire-bonding is used to prove the concept of using body-biasing for making complex logic elements in ultra-thin films. The same logic elements can be synthesized on chip via direct routing. No electrical amplifiers or buffers were used in the testing of these mechanical logic elements.

The graph in Figure 5 shows the results and equivalent truth table for the testing of a mechanical NAND gate formed by using four ultra-thin AlN mechanical switches (Fig. 4(a)) with one input at 100 Hz and the other at 50 Hz with a $\pm 2V$ voltage swing. The frequencies of operation (100 Hz and 50 Hz) were selected for ease of operation and demonstration. The device is not limited to these frequencies and can potentially operate at higher frequencies. In fact, the rise time for these switches has been separately measured to be < 100 nanoseconds. The body biases for this NAND structure were set at $+5.3V$ for the two n-type switches and $-8V$ and $-7.7V$ for the p-type switches.

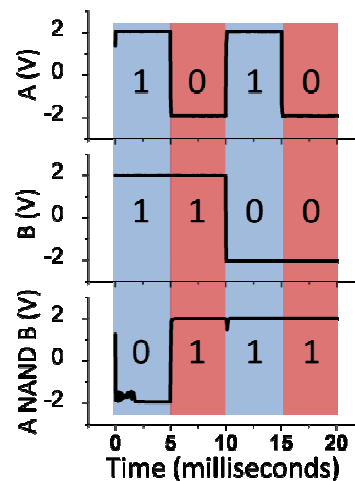


Fig. 5: Experimental data for one cycle of operation of a NAND gate made using ultra-thin AlN mechanical switches (250nm AlN layers) and its corresponding truth table. Note the $\pm 2V$ swing.

The in plane dimensions of the switches have not been scaled proportionally to the thickness. Thus, the device stiffness is significantly reduced. This translates into mechanical bouncing when making contact. It is this dynamical instability that restricted the swing voltage to $\pm 2V$. The bouncing is also the primary reason why the results in Figure 5 show some spikes in the reported data. The bouncing will be significantly attenuated when the structure is further miniaturized, since a higher equivalent stiffness can be engineered. Thus, overall

scaling of the device dimensions will yield the ideal logic system, operating with switching voltages of just few mVs. The graph in Figure 6 shows the results and equivalent truth table for the testing of a mechanical NOR formed by four ultra-thin mechanical switches (Fig. 4(b)) with one input at 100 Hz and the other at 50 Hz with a $\pm 2V$ voltage swing. The body biases for this NOR structure were set at $-4.5V$ for the two p-type switches and $+6.7V$ and $+5.5V$ for the n-type switches. Preliminary contact reliability data for a Au to Pt contact shows that the resistance can be kept below $500\ \Omega$ (sufficient for logic applications) for $> 10^7$ cycles. This data hints that the main issues faced by RF MEMS switches might not be as problematic for computing applications.

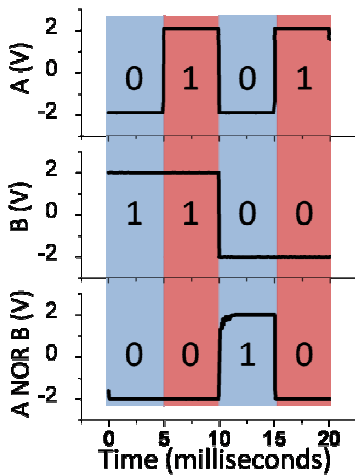


Fig. 6: Experimental data for one cycle of operation of a NOR gate made using ultra-thin AlN mechanical switches (250nm AlN layers) and its corresponding truth table. Note the $\pm 2V$ swing.

CONCLUSIONS

This work demonstrates the scaling of AlN films to 250 nm for making body-biased NAND and NOR logic gates. The scaling is associated with lower threshold and body-bias voltages. NAND and NOR gates in fact operate with a $\pm 2V$ swing and $< 8V$ body bias. Further miniaturization of the switch to the nanoscale will lead to faster and ultra-low-voltage logic components.

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